

IoT-WiFi Module Spec Sheet

FCC ID: 2ATCG-BW682TY

ibeelink

| Version | Time | Author |
|---------|------------|-----------|
| V1.0 | 2018-12-12 | Bruce.lee |
| V1.1 | 2018-12-17 | Bruce.lee |
| V1.2 | 2019-01-30 | Bruce.lee |
| V1.3 | 2019-3-27 | Bruce.lee |
| | | |



1.1 Product Introduction

BW682TYIs ibeelinkCompanyIntroducea highly integratedARMCortex-M4F

Processor, 384KB SRAM, 1MB Flash Module. It Can be widely used in the fields of intelligent household equipment, remote monitoring equipment, medical equipment and the like

1.2 Main Features

- Support 192MHz ARM Cortex M4 MCU with FPU.
- Built –in 384KB SRAM/1MB (8Mbit) FLASH
- Support AES, DES, MD5, SHA1
- Support RTC Mode and XIP Mode
- Working Voltage: DC 3.3V
- Wi-Fi Features:
 - 1. Support 802.11b/g/n (2.4Ghz,1X1) standard, 20M, 40M Bandwidth
 - 2. Support Station and Soft AP Mode
 - 3. Support APK, WechatOfficialAccount, Webbrowser and so on Configure Network
 - 4. Support WEP/WPA2/WPS Security
 - 5. Support Dynamic Switch STA to Soft AP Mode
 - 6. Integration Balun/PA/LNA
 - 7. Support Multi Cloud Connect
- Peripheral Interface:
 - 1. UARTX3(3mbps)
 - 2. PWMX5
 - 3.SDIO 2.0 Masterx1, 2.0 SlaveX1
 - 4.12S X 2(Master or Slave) TX/RX with 16/24/48/96/192 kHz ,11.025kHz, 22.05kHz, 44.1kHz frequencies
 - 5.I2C X 1
 - 6.SPI X2(MasterX1,Slave X1)
 - 7.1 Chanel 12bit ADC
 - 8. Up to 12 GPIOs
- Support FreeRtos OS
- Support Secure Boot
- Comply with FCC rules part 15 subpart C



1.3 Electrical Parameters

1.3.1 Power Performance

| Operation Mode | | Test Conditions | Current | Unit |
|----------------|-----------------|---|-----------------------------|------|
| Power Mode | Scenario | | Consumptions ⁽¹⁾ | |
| OFF | OFF | CHIP_EN keeps low | < 0.5 | μА |
| RETENTION | RETENTION | RTC timer | 2.7 | μА |
| | | OKB SRAM data retention | | |
| | | RTC timer | 4.7 | μА |
| | | 8KB SRAM data retention | | |
| SLEEP | SLEEP_ext_32Khz | Cortex-M4 in sleep state | 110 | μΑ |
| | | TCM 96KB SRAM is retained | | |
| | | SYSRAM 384KB SRAM is retained | | |
| | | XTAL 32kHz | | |
| | SLEEP_int_32Khz | Cortex-M4 in sleep state | 380 | μА |
| | | TCM 96KB SRAM is retained | | |
| | | SYSRAM 384KB SRAM is retained | | |
| | | Internal 32kHz | | |
| ACTIVE | Wi-Fi TX | CCK 19dBm | 248 | mΑ |
| | | N9 in idle state | | |
| | | Cortex-M4 in active state | | |
| | | TCM 96KB SRAM is retained | | |
| | | XTAL 32kHz | | |
| | | OFDM 16.5dBm | 220 | mA |
| | | N9 in idle state | | |
| | | Cortex-M4 in active state | | |
| | | TCM 96KB SRAM is retained | | |
| | | XTAL 32kHz | | |
| | Wi-Fi RX | HT20_MCS7 | 42 | mA |
| | | N9 in active state | | |
| | | Cortex-M4 in active state | | |
| | | XTAL 32kHz | | |
| | | HT20_MCS7 | 30 | mA |
| | | N9 in idle state | | |
| | | Cortex-M4 in sleep state | | |
| | | XTAL 32kHz | | |
| ACTIVE & | DTIM = 1 | Cortex-M4 in sleep state | 620 | μА |
| SLEEP | I | TCM 96KB SRAM is retained | | 1 |

Remark: If Set Then DTIM=10, Low Power may be less than 500uA.

1.3.2 Work Environment

- 1. Suggest Operating Conditions: -20 to 80° C,
- 2. WiFi During Normal Work Peak Current Dot less than 400mA.





1.4 RF Performance

1.4.1 Transmitter and Receiver Performance

| Modulation | RATED MIN. POWER(dBm) | RATED MAX. POWER (dBm) |
|---------------|-----------------------|------------------------|
| 802.11 B | 15 | 18 |
| 802.11 G | 13 | 16 |
| 802.11 N/HT20 | 12 | 15 |
| 802.11 N/HT40 | 11 | 14 |

Receiver sensitivity:

| 802.11b 2.4GHz Band | Criterion Limit Unit: dBm | | Receiver Sensitivity Test Channel | |
|------------------------|---------------------------------|------|-----------------------------------|------|
| Mode / Rate | Min. Max. | | CH10 | P/F |
| CCK 1M | | -80 | - 97.5 | Pass |
| CCK 2M | | -80 | -94.5 | Pass |
| CCK 5.5M | | -76 | - 92.5 | Pass |
| CCK 11M | | -76 | -89.5 | Pass |
| 802.11g 2.4GHz Band | Criterion Limit Unit: dBm | | Receiver Sensitivity Test Channel | |
| Mode / Rate | Min. | Max. | CH10 | P/F |
| OFDM-6M | | -82 | -94.5 | Pass |
| OFDM-9M | | -81 | -92.5 | Pass |
| OFDM-12M | | -79 | -91.5 | Pass |
| OFDM-18M | | -77 | -89 | Pass |
| OFDM-24M | | -74 | -86 | Pass |
| OFDM-36M | | -70 | -82.5 | Pass |
| OFDM-48M | | -66 | -78.5 | Pass |
| OFDM-54M | | -65 | -77 | Pass |

ibeelink

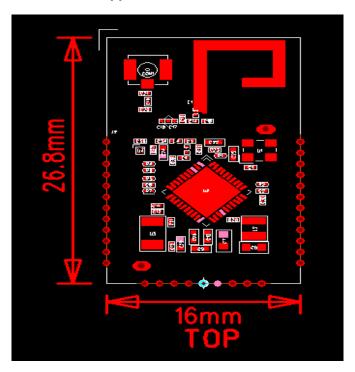
iBeeLink Everywhere

| 802.11n 2.4GHz Band | Criterion Limit Unit: dBm | | Receiver Sensitivity Test Channel | |
|---|---------------------------------|---------------------|---|--------------------------|
| Mode / Rate | Min. | Max. | CH10 | P/F |
| HT20-MCS0 | | -82 | -94 | Pass |
| HT20-MCS1 | | -79 | -90.5 | Pass |
| HT20-MCS2 | | -77 | -88 | Pass |
| HT20-MCS3 | | -74 | -85.5 | Pass |
| HT20-MCS4 | | -70 | -81.5 | Pass |
| HT20-MCS5 | | -66 | -77.5 | Pass |
| HT20-MCS6 | | -65 | -76 | Pass |
| HT20-MCS7 | | -64 | -74.5 | Pass |
| | | | | |
| 802.11n 2.4GHz Band | Lin | erion nit dBm | Receiver Sensitivity Test Channel | |
| | Lin | nit | * | P/F |
| 2.4GHz Band | Lir Unit: | nit dBm | Test Channel | P/F Pass |
| 2.4GHz Band Mode / Rate | Lir Unit: | dBm Max. | Test Channel CH10 | |
| 2.4GHz Band Mode / Rate HT40-MCS0 | Lir Unit: | mit dBm Max. | Test Channel CH10 -90.5 | Pass |
| 2.4GHz Band Mode / Rate HT40-MCS0 HT40-MCS1 | Lir Unit: | Max79 -76 | Test Channel CH10 -90.5 -87.5 | Pass Pass |
| 2.4GHz Band Mode / Rate HT40-MCS0 HT40-MCS1 HT40-MCS2 | Lir Unit: | Max. -79 -76 | Test Channel CH10 -90.5 -87.5 -85 | Pass Pass Pass |
| 2.4GHz Band Mode / Rate HT40-MCS0 HT40-MCS1 HT40-MCS2 HT40-MCS3 | Lir Unit: | Max79 -76 -74 | Test Channel CH10 -90.5 -87.5 -85 -82 | Pass Pass Pass |
| 2.4GHz Band Mode / Rate HT40-MCS0 HT40-MCS1 HT40-MCS2 HT40-MCS3 HT40-MCS4 | Lir Unit: | Max79 -76 -74 -71 | Test Channel CH10 -90.5 -87.5 -85 -82 -78.5 | Pass Pass Pass Pass Pass |

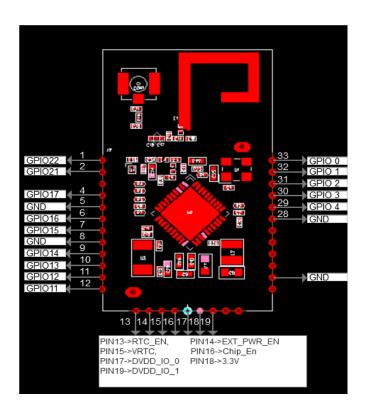


ibeelink 1.5 Physical Properties Description

1.5.1 Module Appearance

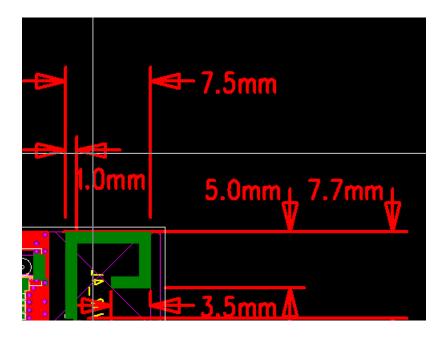


PIN Name Define:

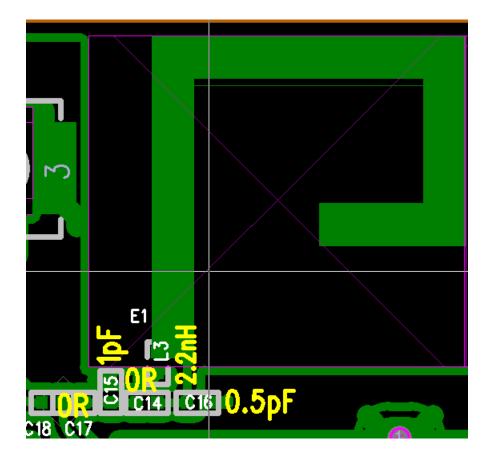




PCB Antenna



Antenna matching parameters see bellow device C17, C15, C14, L3, C16



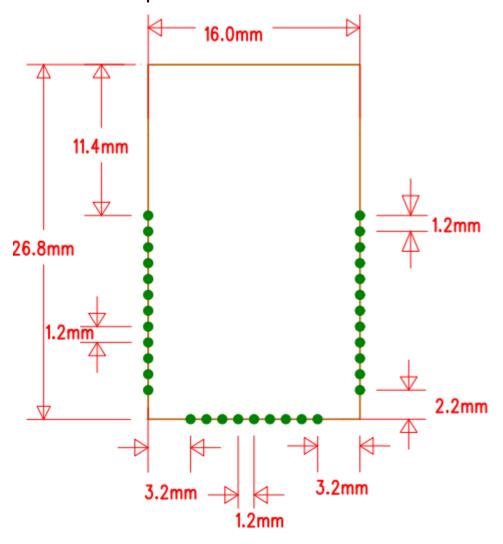


Note 1: This module contains only the PCB antenna described above, max. gain is 1dBi.

Note 2: Any deviation(s) from the defined parameters of the antenna trace, as described by the instructions, require that the host product manufacturer must notify the module grantee that they wish to change the antenna trace design. In this case, a Class II permissive change application is required to be filed by the grantee, or the host manufacturer can take responsibility through the change in FCC ID (new application) procedure followed by a Class II permissive change application.



1.5.2 Module Size Specifications



PIN Function Description

| | | r | r . | | | r . | | | | r | |
|---------|--------|-------------------|-------------------|--------|----------------|-----------------|---------|--------|-------------------|-------------------|-------------------|
| Ball | Aux | Aux | Aux | Aux | Aux | Aux | Aux | Aux | Aux | Aux | Aux |
| Name | Func.0 | Func.1 | Func.2 | Func.3 | Func.4 | Func.5 | Func.6 | Func.7 | Func.8 | Func.9 | Func.10 |
| GPIO_0 | GPI00 | EINTO | | U1RTS | SCL1 | I2S_RX | JTDI | | WIFI_ANT_S ELO | BT_PRI1 | PWM0 |
| GPIO_1 | GPIO1 | EINT1 | | U1CTS | SDA1 | I2S_TX | JTMS | | WIFI_ANT_S EL1 | BT_PRI3 | PWM1 |
| GPIO_2 | GPIO2 | EINT2 | | URXD1 | PWM0 | I2S_WS | JTCK | CLK00 | | BT_PRIO | WIFI_ANT_S EL4 |
| GPIO_3 | GPIO3 | EINT3 | | UTXD1 | PWM1 | I2S_CK | JTRST_B | | | WIFI_ANT_S EL2 | I2S_CK |
| GPIO_4 | GPIO4 | SPISLV_A_SI O2 | SPIMST_A_SI O2 | EINT4 | | I2S_MCLK | JTDO | | | WIFI_ANT_S EL3 | I2S_MCLK |
| GPIO_11 | GPIO11 | EINT11 | PWM3 | URXD2 | MA_MCO_CK | SLV_MC0_CK | CLKO2 | | | WIFI_ANT_S ELO | I2S_RX |
| GPIO_12 | GPIO12 | SPISLV_B_SI O3 | SPIMST_B_SI O3 | UTXD2 | MA_MC0_C M0 | SLV_MC0_C M0 | EINT12 | | | WIFI_ANT_S EL1 | I2S_TX |
| GPIO_13 | GPIO13 | SPISLV_B_SI O2 | SPIMST_B_SI O2 | U2RTS | MA_MC0_D A0 | SLV_MC0_D A0 | CLKO4 | | EINT13 | | I2S_WS |
| GPIO_14 | GPIO14 | SPISLV_B_SI O1 | SPIMST_B_SI O1 | TDM_RX | MA_MC0_D A1 | SLV_MC0_D A1 | PWM4 | | EINT14 | | CLKO4 |
| GPIO_15 | GPIO15 | SPISLV_B_SI OO | SPIMST_B_SI OO | TDM_TX | MA_MC0_D A2 | SLV_MC0_D A2 | SCL1 | | EINT15 | | PWM3 |
| GPIO_16 | GPIO16 | SPISLV_B_SC K | SPIMST_B_S CK | TDM_WS | MA_MC0_D A3 | SLV_MC0_D A3 | SDA1 | | EINT16 | | |
| GPIO_17 | GPIO17 | SPISLV_B_CS | SPIMST_B_C S | TDM_CK | PWM5 | CLKO3 | AUXADC0 | | EINT17 | | BT_PRIO |
| GPIO_21 | GPIO21 | URXDO | EINT19 | SCL1 | | PWM5 | | | | | |
| GPIO_22 | GPIO22 | UTXD0 | EINT20 | | | | | | | | |

Remarks:

All GPIO Function Can be Configuration by software in SDK.



1.5.4 Application attention

1. Power –On Sequence

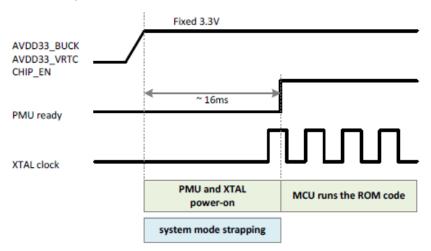


Figure 4.5-1. Power-on sequence

2. Some GPIO Pin During Power-Up By HW to Configuration

| Mode Selection | Pin name | Description | Trapping condition |
|---|-------------|---|------------------------------------|
| XO source frequency select | GPIO_17 | GND : XO input is 26MHz (default) DVDD_IO_0 : XO input is 40MHz | Core reset |
| 32kHz clock source select | GPIO_14 | GND : 32kHz source is from external DVDD_IO_0 : 32kHz source is from internal (divided from 26/40MHz clock) (default) | Core reset |
| Boot with host interface (HIF_EN) | GPIO_4 | GND : Boot with host interface disabled (default) DVDD_IO_1: Boot with host interface enabled | Core reset |
| Host interface select (active if HIF_EN is enabled) | GPIO_13 | (Active if HIF_EN = 1) GND : Host interface via SPI slave DVDD_IO_0: Host interface via SDIO slave (default) | Core reset |
| Boot ROM bypass select | GPIO_16 | GND : Boot up bypass boot ROM (directly jump to flash) DVDD_IO_0 : Boot up with boot ROM (default) | Core reset |
| JTAG pins fixed for use | GPIO_15 | GND : JTAG pins fixed for JTAG use DVDD_IO_0: JTAG pins as GPIO (configurable after boot up) (default) | Core reset |
| UART download | GPIO_12 | GND : Enter UART download mode in Boot ROM DVDD_IO_0 : Skip UART download in Boot ROM (default) | Core reset or watchdog reset |

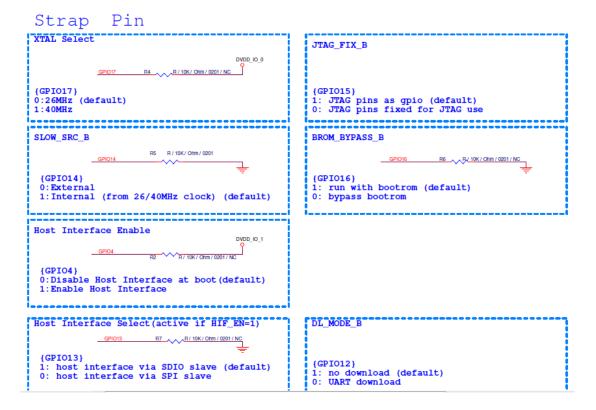
Note 1: Strapping resistors for default option are implemented as internal pull-down or internal pull-up. (Refer to DRPU* and DRPD* in Table 6.2-5 for internal pull-up and pull-down resistor value.)

Note 2: If non-default option is used, it is recommended to use pull-down or pull-up $10k\Omega$ as external strapping resistors.

Note 3: SDIO master and slave interfaces are limited to 1-bit mode if the 32kHz source is from external.



The reference circuit is as follows:



FCC Statements

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference, and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

FCC Radiation Exposure Statement

The modular can be installed or integrated in mobile or fix devices only. This modular cannot be installed in any portable device, for example, USB dongle like transmitters is forbidden.

This modular complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or

ibeelink

iBeeLink Everywhere

operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body.

If the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following: "Contains Transmitter Module FCC ID: 2ATCG-BW682TY Or Contains FCC ID: 2ATCG-BW682TY"

When the module is installed inside another device, the user manual of this device must contain below warning statements:

- 1. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:
- (1) This device may not cause harmful interference, and (2) This device must accept any interference received, including interference that may cause undesired operation.
- 2. Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The devices must be installed and used in strict accordance with the manufacturer's instructions as described in the user documentation that comes with the product.

The host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification. The final host product still requires Part 15 Subpart B compliance testing with the modular transmitter installed. The end user manual shall include all required regulatory information/warning as shown in this manual, include:

This product must be installed and operated with a minimum distance of 20 cm between the radiator and user body.



Contact Information:

ShangHaiiBeeLink Company

Room 402-17, 4/F, Building No.5, No.2388, ChenHang Road,

MinHang District, ShangHai 201114, P.R.China

Contacts: Randy.ding

Tel: 0755-86018818

Fax: 0755-86018808

Mobile: 18676680772